

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): Lieb et al.  
Serial No.: 10/511,566  
For: PROCESS FOR FORMING A HOUSING FOR ELECTRONIC  
MODULES, AND ELECTRONIC MODULES ECAPSULATED IN  
THIS WAY  
Filed: April 13, 2005  
Examiner: Andrew O. Arena  
Art Unit: 2811  
Confirmation No.: 4191  
Customer No.: 27,623

Attorney Docket No.: 2133.063USU

**Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450**

**AMENDMENT ACCOMPANYING REQUEST FOR CONTINUED EXAMINATION**

Dear Sir:

In response to the Office Action dated September 28, 2009, the period for response having been extended three (3) months up to and including March 29, 2010, please amend the above-identified application as follows:

**Listing of the Claims** begins on page **2** of this paper.

**Remarks** begin on page **8** of this paper.